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## STF6N90K5

## N-channel 900 V, $0.91 \Omega$ typ., 6 A MDmesh ${ }^{\text {TM }}$ K5 Power MOSFET in a TO-220FP package

Datasheet - production data


Figure 1: Internal schematic diagram


Features

| Order code | VDs | Rds(on) max. | Id |
| :---: | :---: | :---: | :---: |
| STF6N90K5 | 900 V | $1.10 \Omega$ | 6 A |

- Industry's lowest RDS(on) $x$ area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- $100 \%$ avalanche tested
- Zener-protected


## Applications

- Switching applications


## Description

This very high voltage N -channel Power MOSFET is designed using MDmesh ${ }^{\text {TM }}$ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

| Order code | Marking | Package | Packing |
| :---: | :---: | :---: | :---: |
| STF6N90K5 | 6N90K5 | TO-220FP | Tube |

## Contents

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## 1

Electrical ratings
Table 2: Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
| :---: | :---: | :---: | :---: |
| $V_{G S}$ | Gate-source voltage | $\pm 30$ | V |
| ID | Drain current (continuous) at $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $6{ }^{(1)}$ | A |
| ID | Drain current (continuous) at $\mathrm{T}_{\mathrm{C}}=100^{\circ} \mathrm{C}$ | $4{ }^{(1)}$ | A |
| $1 \mathrm{D}^{(2)}$ | Drain current (pulsed) | 24 | A |
| Ртот | Total dissipation at $\mathrm{T} \mathrm{c}=25^{\circ} \mathrm{C}$ | 25 | W |
| dv/dt ${ }^{(3)}$ | Peak diode recovery voltage slope | 4.5 | V/ns |
| $\mathrm{dv} / \mathrm{dt}{ }^{(4)}$ | MOSFET dv/dt ruggedness | 50 |  |
| Viso | Insulation withstand voltage (RMS) from all three leads to external heat $\operatorname{sink}\left(\mathrm{t}=1 \mathrm{~s} ; \mathrm{T}=25^{\circ} \mathrm{C}\right.$ ) | 2500 | V |
| $\mathrm{T}_{\mathrm{j}}$ | Operating junction temperature range | - 55 to 150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ | Storage temperature range |  |  |

## Notes:

${ }^{(1)}$ Limited by package
${ }^{(2)}$ Pulse width limited by safe operating area
${ }^{(3)}$ ISD $\leq 6 \mathrm{~A}$, di/dt $\leq 100 \mathrm{~A} / \mu \mathrm{s}$; VDS peak $<\mathrm{V}_{(B R)}$ DSS, $\mathrm{VDD}=450 \mathrm{~V}$.
${ }^{(4)} \mathrm{V}_{\mathrm{DS}} \leq 720 \mathrm{~V}$

Table 3: Thermal data

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| Rthj-case | Thermal resistance junction-case | 5 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Rthj-amb | Thermal resistance junction-ambient | 62.5 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

Table 4: Avalanche characteristics

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $I_{A R}$ | Avalanche current, repetitive or not repetitive (pulse width <br> limited by $\left.T_{j m a x}\right)$ | 2 | $A$ |
| $E_{A S}$ | Single pulse avalanche energy (starting $T_{j}=25^{\circ} \mathrm{C}, I_{D}=I_{A R}$, <br> $V_{D D}=50 \mathrm{~V}$ ) | 210 | mJ |

## 2 Electrical characteristics

$\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ unless otherwise specified
Table 5: On/off-state

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {(BR) }{ }^{\text {dss }}}$ | Drain-source breakdown voltage | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{ID}=1 \mathrm{~mA}$ | 900 |  |  | V |
| Idss | Zero gate voltage drain current | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=900 \mathrm{~V}$ |  |  | 1 | $\mu \mathrm{A}$ |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=900 \mathrm{~V} \\ & \mathrm{~T}_{\mathrm{C}}=125^{\circ} \mathrm{C}^{(1)} \end{aligned}$ |  |  | 50 | $\mu \mathrm{A}$ |
| Igss | Gate body leakage current | $\mathrm{V}_{\mathrm{DS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}$ |  |  | $\pm 10$ | $\mu \mathrm{A}$ |
| VGS(th) | Gate threshold voltage | $V_{\text {DD }}=\mathrm{V}_{\mathrm{GS}}, \mathrm{ld}=100 \mu \mathrm{~A}$ | 3 | 4 | 5 | V |
| RDS(on) | Static drain-source onresistance | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{ld}=3 \mathrm{~A}$ |  | 0.91 | 1.10 | $\Omega$ |

## Notes

${ }^{(1)}$ Defined by design, not subject to production test.

Table 6: Dynamic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{C}_{\text {iss }}$ | Input capacitance | $\begin{aligned} & \mathrm{VDS}=100 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}, \\ & \mathrm{VGS}=0 \mathrm{~V} \end{aligned}$ | - | 342 | - | pF |
| Coss | Output capacitance |  | - | 31 | - | pF |
| Crss | Reverse transfer capacitance |  | - | 1.2 | - | pF |
| $\mathrm{Co}_{\text {(tr) }}{ }^{(1)}$ | Equivalent capacitance time related | $\begin{aligned} & \mathrm{V}_{\mathrm{DS}}=0 \text { to } 720 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V} \end{aligned}$ | - | 55 | - | pF |
| $\mathrm{Co}_{\text {(er) }}{ }^{(2)}$ | Equivalent capacitance energy related |  | - | 20 | - | pF |
| $\mathrm{R}_{\mathrm{g}}$ | Intrinsic gate resistance | $\mathrm{f}=1 \mathrm{MHz}, \mathrm{ld}=0 \mathrm{~A}$ | - | 6.4 | - | $\Omega$ |
| $\mathrm{Q}_{\mathrm{g}}$ | Total gate charge | $\begin{aligned} & \mathrm{V} D \mathrm{DD}=720 \mathrm{~V}, \mathrm{ID}=6 \mathrm{~A} \\ & \mathrm{~V} G=10 \mathrm{~V} \end{aligned}$ <br> (see Figure 15: "Test circuit for gate charge behavior") | - | 11 | - | nC |
| $\mathrm{Qgs}^{\text {s }}$ | Gate-source charge |  | - | 2.5 | - | nC |
| $\mathrm{Q}_{\mathrm{gd}}$ | Gate-drain charge |  | - | 7 | - | nC |

## Notes:

${ }^{(1)} \mathrm{C}_{o(t r)}$ is a constant capacitance value that gives the same charging time as Coss while VDs is rising from 0 to $80 \%$ Vdss.
${ }^{(2)} \mathrm{C}_{o(\text { er) }}$ is a constant capacitance value that gives the same stored energy as $\mathrm{C}_{\text {oss }}$ while $\mathrm{V}_{\mathrm{DS}}$ is rising from 0 to $80 \%$ VDSs.

Table 7: Switching times

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{td}_{\text {don) }}$ | Turn-on delay time | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=450 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=3 \mathrm{~A}, \mathrm{R}_{\mathrm{G}}=4.7 \Omega \\ & \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V} \end{aligned}$ <br> (see Figure 14: "Test circuit for resistive load switching times" and Figure 19: "Switching time waveform") | - | 12.4 | - | ns |
| tr | Rise time |  | - | 12.2 | - | ns |
| td(off) | Turn-off delay time |  | - | 30.4 | - | ns |
| $t_{f}$ | Fall time |  | - | 15.5 | - | ns |

Table 8: Source-drain diode

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Isd | Source-drain current |  | - |  | 6 | A |
| Istm ${ }^{(1)}$ | Source-drain current (pulsed) |  | - |  | 24 | A |
| $\mathrm{VSD}^{(2)}$ | Forward on voltage | $\mathrm{I}_{\mathrm{SD}}=6 \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ | - |  | 1.5 | V |
| $t_{\text {rr }}$ | Reverse recovery time | $\begin{aligned} & \mathrm{ISD}=6 \mathrm{~A}, \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mathrm{\mu s}, \\ & \mathrm{~V}_{\mathrm{DD}}=60 \mathrm{~V} \end{aligned}$ <br> (see Figure 16: "Test circuit for inductive load switching and diode recovery times") | - | 342 |  | ns |
| Qrr | Reverrse recovery charge |  | - | 3.13 |  | $\mu \mathrm{C}$ |
| IRRM | Reverse recovery current |  | - | 18.3 |  | A |
| $\mathrm{trr}^{\text {r }}$ | Reverse recovery time | $\begin{aligned} & \mathrm{IsD}=6 \mathrm{~A}, \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s}, \\ & \mathrm{~V}_{\mathrm{DD}}=60 \mathrm{~V}, \mathrm{~T}_{\mathrm{j}}=150^{\circ} \mathrm{C} \end{aligned}$ <br> (see Figure 16: "Test circuit for inductive load switching and diode recovery times') | - | 536 |  | ns |
| Qrr | Reverse recovery charge |  | - | 4.42 |  | $\mu \mathrm{C}$ |
| IRRM | Reverse recovery current |  | - | 16.5 |  | A |

## Notes:

${ }^{(1)}$ Pulse width limited by safe operating area
${ }^{(2)}$ Pulsed: pulse duration $=300 \mu$ s, duty cycle $1.5 \%$

Table 9: Gate-source Zener diode

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{(\mathrm{BR}) \mathrm{GsO}}$ | Gate-source breakdown voltage | $\mathrm{I} \mathrm{GS}= \pm 1 \mathrm{~mA}, \mathrm{ID}=0 \mathrm{~A}$ | 30 | - | - | V |

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

### 2.1 Electrical characteristics (curves)



Figure 4: Output characteristics


Figure 5: Transfer characteristics


Figure 6: Gate charge vs gate-source voltage


Figure 7: Static drain-source on-resistance



Figure 10: Normalized on-resistance vs temperature


Figure 11: Normalized $\mathbf{V}_{\text {(BR)Dss }}$ vs temperature


Figure 12: Maximum avalanche energy vs starting $\mathrm{T}_{\mathrm{J}}$


Figure 13: Source-drain diode forward characteristics


## 3 <br> Test circuits



Figure 18: Unclamped inductive waveform


Figure 19: Switching time waveform


## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK ${ }^{\circledR}$ packages, depending on their level of environmental compliance. ECOPACK ${ }^{\circledR}$ specifications, grade definitions and product status are available at: www.st.com. ECOPACK ${ }^{\circledR}$ is an ST trademark.
4.1 TO-220FP package information

Figure 20: TO-220FP package outline


| Table 10: TO-220FP package mechanical data |  |  |  |
| :---: | :---: | :---: | :---: |
|  | mm |  |  |
| Dim. | Min. | Typ. | Max. |
| A | 4.4 |  | 4.6 |
| B | 2.5 |  | 2.7 |
| D | 2.5 |  | 2.75 |
| E | 0.45 |  | 0.7 |
| F | 0.75 |  | 1 |
| F1 | 1.15 |  | 1.70 |
| F2 | 1.15 |  | 1.70 |
| G | 4.95 |  | 5.2 |
| G1 | 2.4 |  | 10.7 |
| H | 10 |  | 30.6 |
| L2 | 28.6 |  | 10.6 |
| L3 | 9.8 |  | 3.6 |
| L4 | 2.9 |  | 16.4 |
| L5 | 15.9 |  | 9.3 |
| L6 | 9 |  | 3.2 |
| L7 | 3 |  |  |
| Dia |  |  |  |

## 5 Revision history

Table 11: Document revision history

| Date | Revision | Changes |
| :---: | :---: | :--- |
| 02-Nov-2016 | 1 | First release. |

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